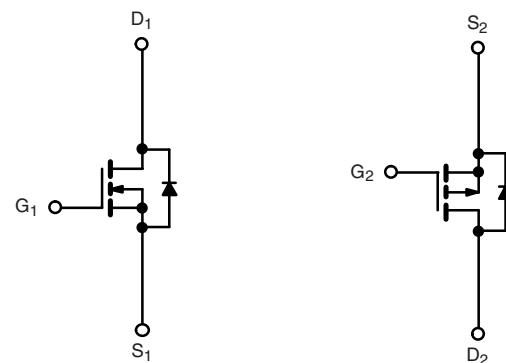
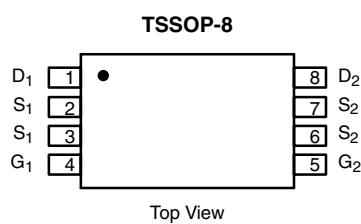


## N- and P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY			
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> ( $\Omega$ )	I <sub>D</sub> (A)
N-Channel	30	0.032 at V <sub>GS</sub> = 10 V	4.3
		0.046 at V <sub>GS</sub> = 4.5 V	3.7
P-Channel	- 30	0.043 at V <sub>GS</sub> = - 10 V	- 3.8
		0.073 at V <sub>GS</sub> = - 4.5 V	- 2.8

### FEATURES

- Halogen-free
- TrenchFET® Power MOSFETS


**RoHS**  
COMPLIANT


Ordering Information: Si6544BDQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS T<sub>A</sub> = 25 °C, unless otherwise noted

Parameter	Symbol	N-Channel		P-Channel		Unit	
		10 s	Steady State	10 s	Steady State		
Drain-Source Voltage	V <sub>DS</sub>		30		- 30	V	
Gate-Source Voltage	V <sub>GS</sub>		± 20				
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	I <sub>D</sub>	4.3	3.7	- 3.8	A	
	T <sub>A</sub> = 70 °C		3.5	3.0	- 3.0		
Pulsed Drain Current	I <sub>DM</sub>	20		- 20		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	1.0	0.7	- 1.0	- 0.7		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.14	0.83	1.14	0.83	W
	T <sub>A</sub> = 70 °C		0.73	0.53	0.73	0.53	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C	

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10 s	R <sub>thJA</sub>	88	110
	Steady State		120	150
Maximum Junction-to-Foot (Drain)	R <sub>thJF</sub>	65	80	°C/W

Notes:

a. Surface Mounted on FR4 board, t ≤ 10 s.

**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions		Min.	Typ.	Max.	Unit
<b>Static</b>							
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	N-Ch	1.0		3.0	V
		$V_{DS} = V_{GS}$ , $I_D = -250 \mu\text{A}$	P-Ch	-1.0		-3.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}$ , $V_{GS} = \pm 20 \text{ V}$	n-ch			$\pm 100$	nA
			N-Ch			$\pm 100$	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30 \text{ V}$ , $V_{GS} = 0 \text{ V}$	P-Ch			1	$\mu\text{A}$
		$V_{DS} = -30 \text{ V}$ , $V_{GS} = 0 \text{ V}$	N-Ch			-1	
		$V_{DS} = 30 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 55^\circ\text{C}$	P-Ch			5	
		$V_{DS} = -30 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_J = 55^\circ\text{C}$	N-Ch			-5	
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} \geq 5 \text{ V}$ , $V_{GS} = 10 \text{ V}$	P-Ch	20			A
		$V_{DS} \geq -5 \text{ V}$ , $V_{GS} = -10 \text{ V}$	N-Ch	-20			
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$ , $I_D = 4.3 \text{ A}$	P-Ch		0.025	0.032	$\Omega$
		$V_{GS} = -10 \text{ V}$ , $I_D = -3.8 \text{ A}$	N-Ch		0.034	0.043	
		$V_{GS} = 4.5 \text{ V}$ , $I_D = 3.7 \text{ A}$	P-Ch		0.037	0.046	
		$V_{GS} = -4.5 \text{ V}$ , $I_D = -2.8 \text{ A}$	N-Ch		0.058	0.073	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}$ , $I_D = 4.3 \text{ A}$	P-Ch		11		S
		$V_{DS} = -15 \text{ V}$ , $I_D = -3.8 \text{ A}$	N-Ch		11		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 1.25 \text{ A}$ , $V_{GS} = 0 \text{ V}$	P-Ch		0.77	1.1	V
		$I_S = -1.25 \text{ A}$ , $V_{GS} = 0 \text{ V}$	N-Ch		-0.77	-1.1	
<b>Dynamic<sup>b</sup></b>							
Total Gate Charge	$Q_g$	N-Channel $V_{DS} = 15 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 4.3 \text{ A}$ P-Channel $V_{DS} = -15 \text{ V}$ , $V_{GS} = -10 \text{ V}$ , $I_D = -3.8 \text{ A}$	N-Ch		9.5	15	nC
Gate-Source Charge	$Q_{gs}$		P-Ch		16	25	
Gate-Drain Charge	$Q_{gd}$		N-Ch		1.8		
Gate Resistance	$R_g$		P-Ch		2.3		
Turn-On Delay Time	$t_{d(\text{on})}$	N-Channel $V_{DD} = 15 \text{ V}$ , $R_L = 15 \Omega$ $I_D \geq 1 \text{ A}$ , $V_{GEN} = 10 \text{ V}$ , $R_G = 6 \Omega$ P-Channel $V_{DD} = -15 \text{ V}$ , $R_L = 15 \Omega$ $I_D \geq -1 \text{ A}$ , $V_{GEN} = -10 \text{ V}$ , $R_G = 6 \Omega$	N-Ch		1.55		ns
Rise Time	$t_r$		P-Ch		4.5		
Turn-Off Delay Time	$t_{d(\text{off})}$		N-Ch		0.45		
Fall Time	$t_f$		P-Ch		8.8		
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 1.25 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$	N-Ch		13	25	ns
		$I_F = -1.25 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$	P-Ch		14	25	

Notes:

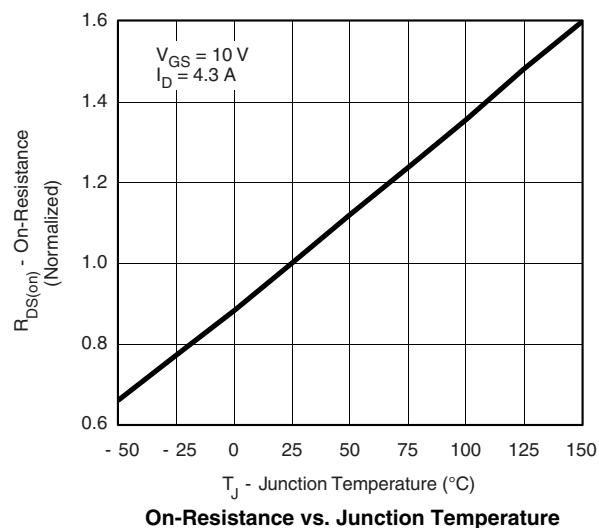
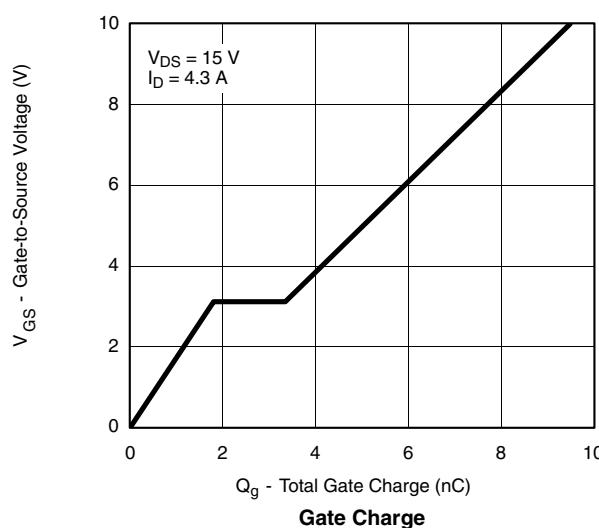
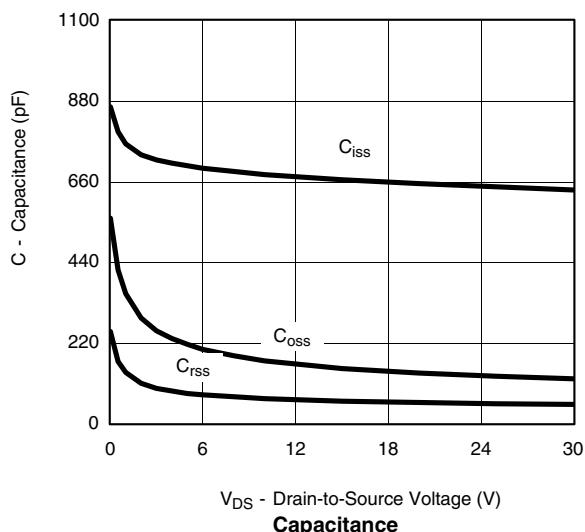
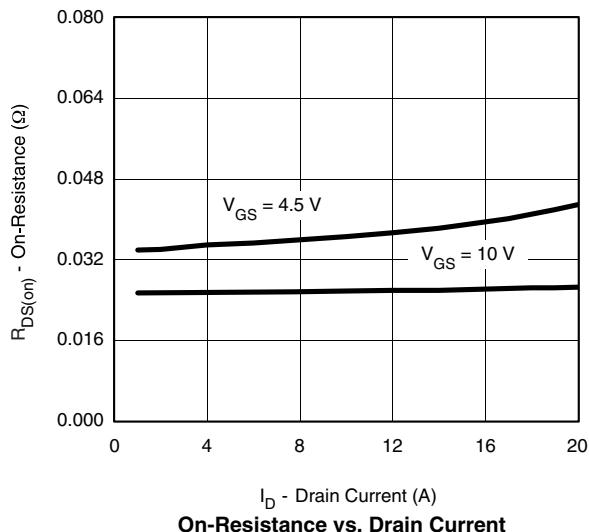
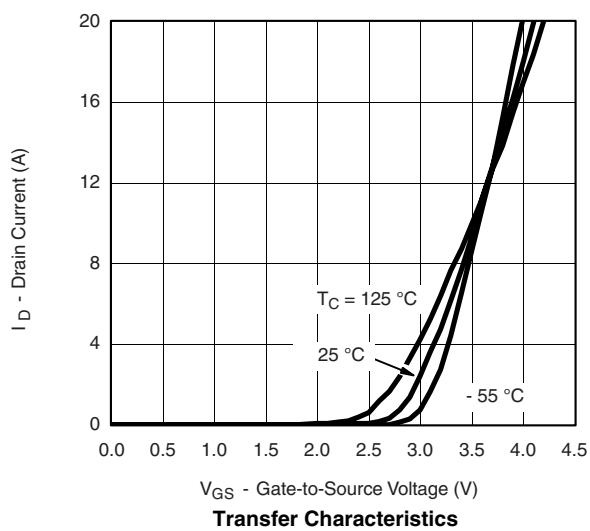
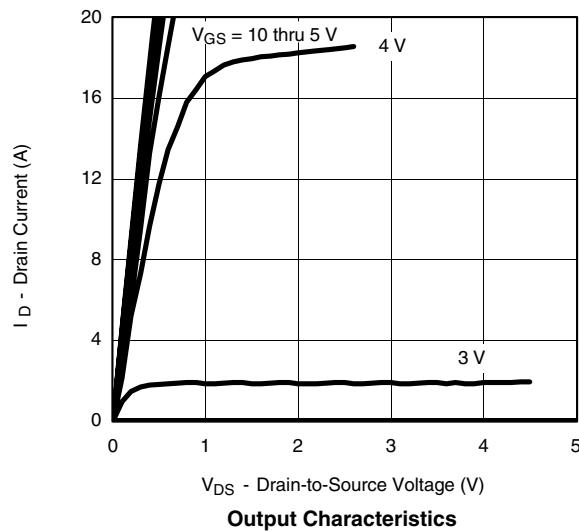
a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

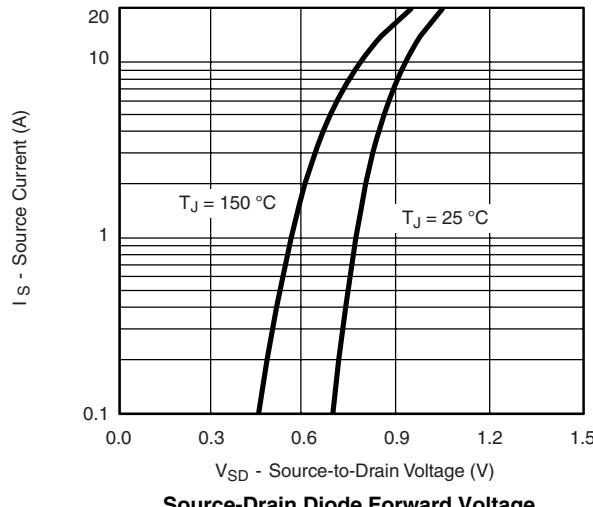
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

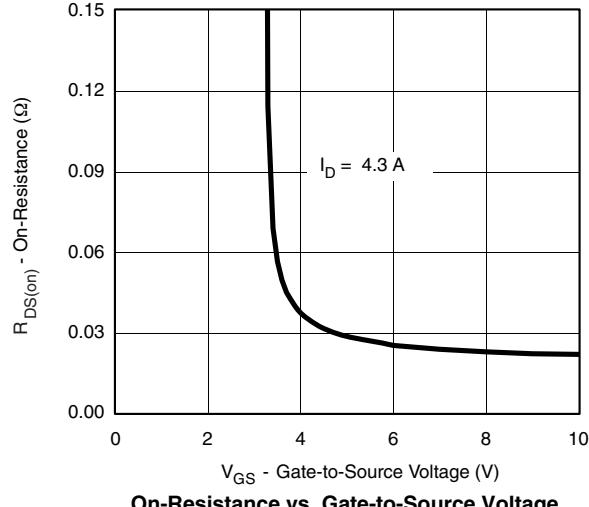
**N-CHANNEL TYPICAL CHARACTERISTICS**

25 °C, unless otherwise noted

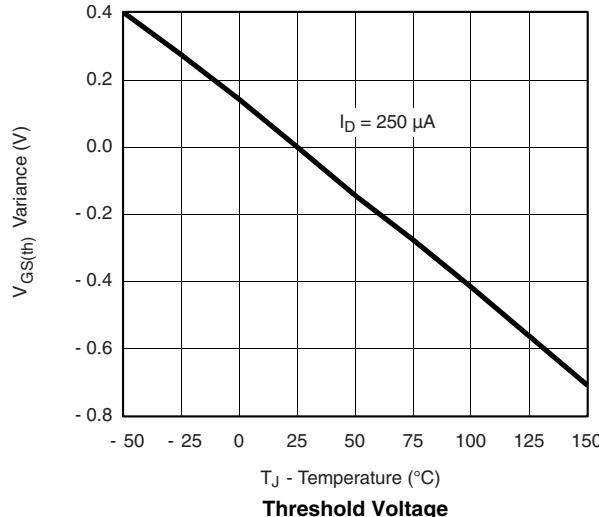


**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


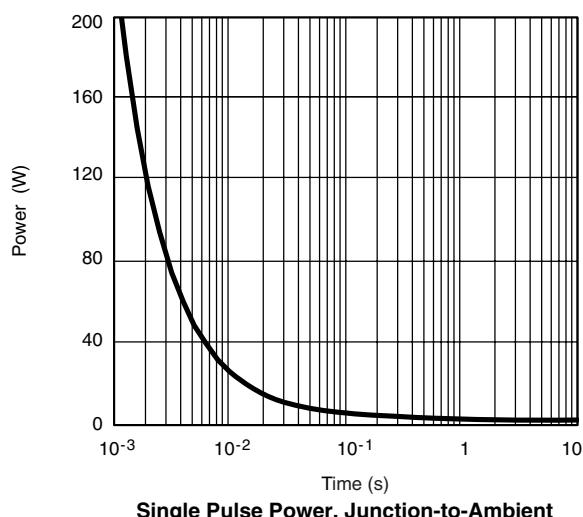
Source-Drain Diode Forward Voltage



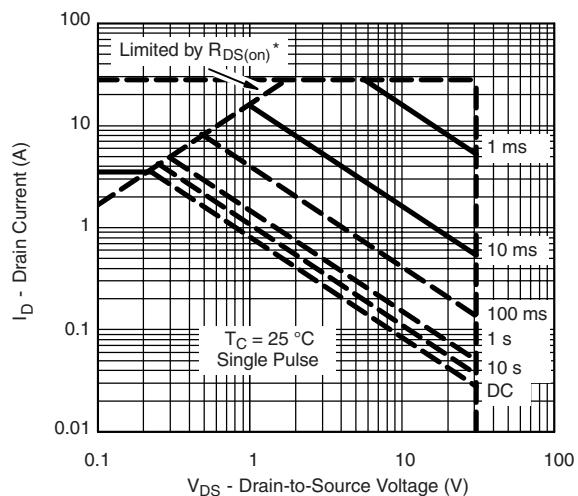
On-Resistance vs. Gate-to-Source Voltage



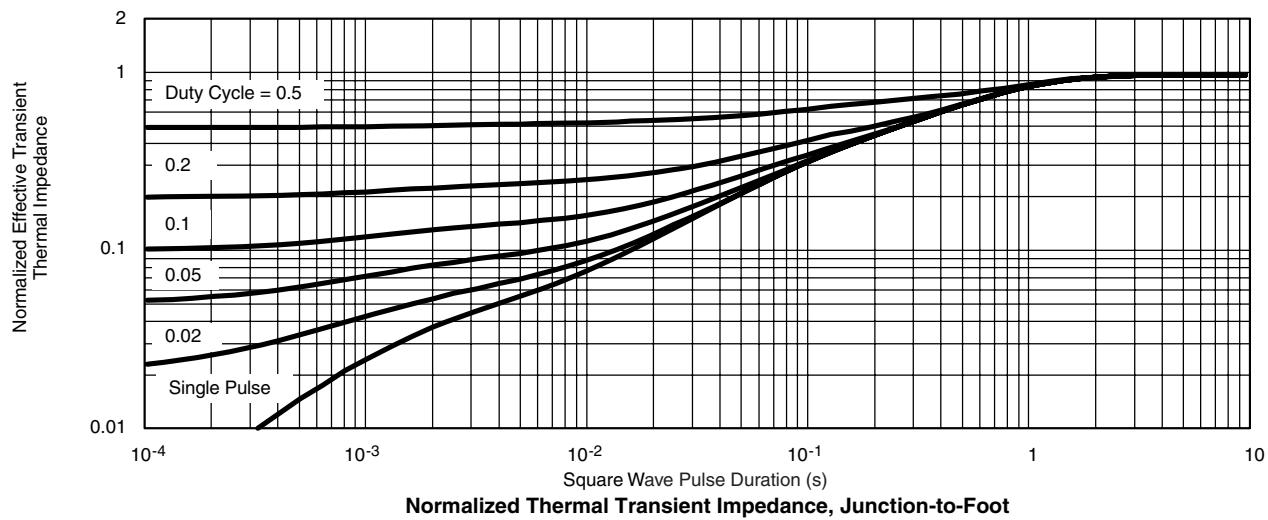
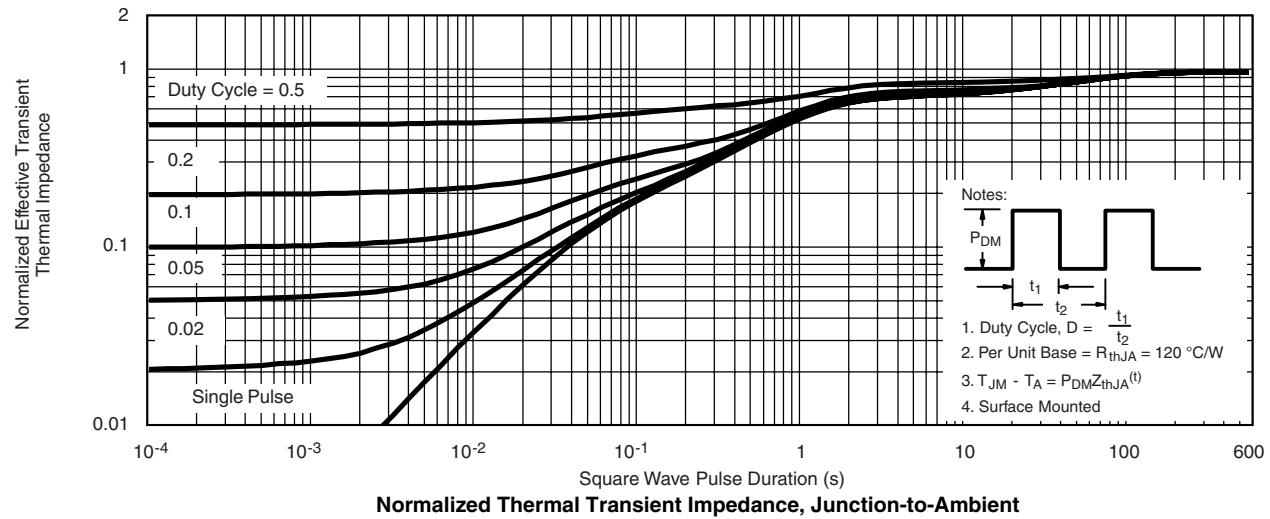
Threshold Voltage



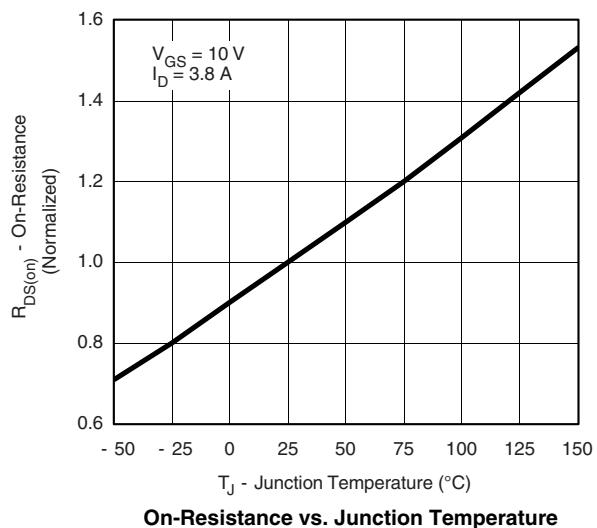
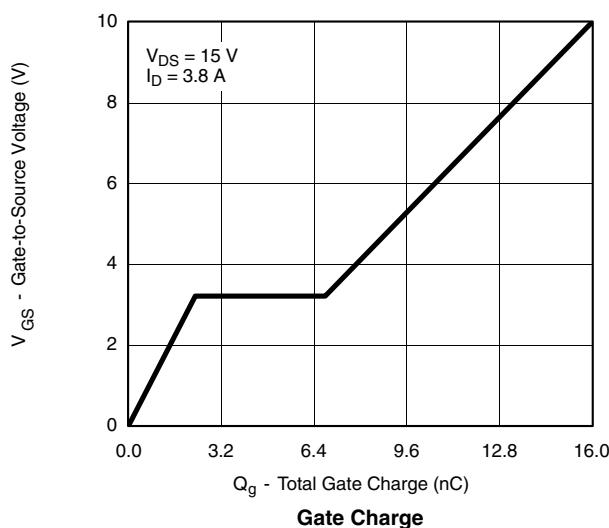
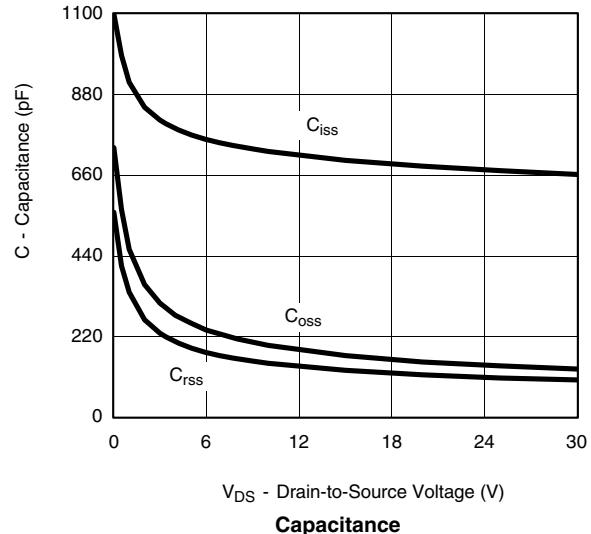
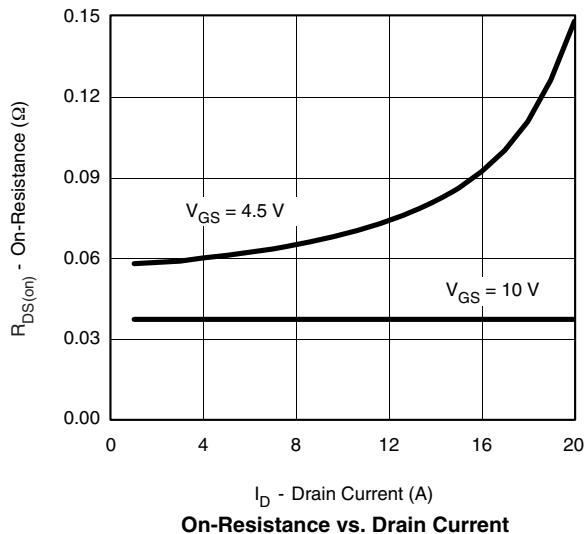
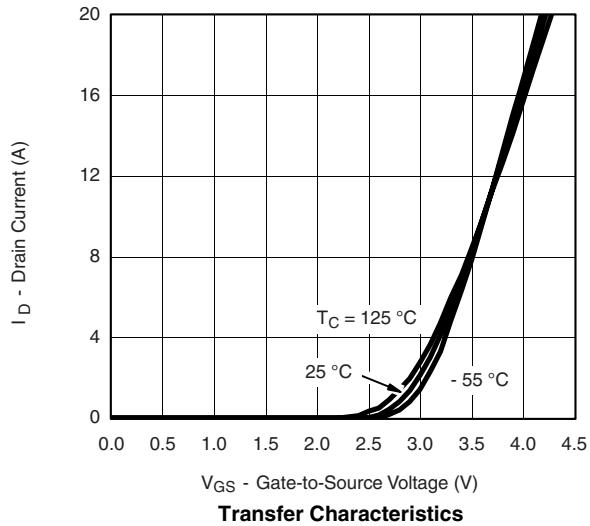
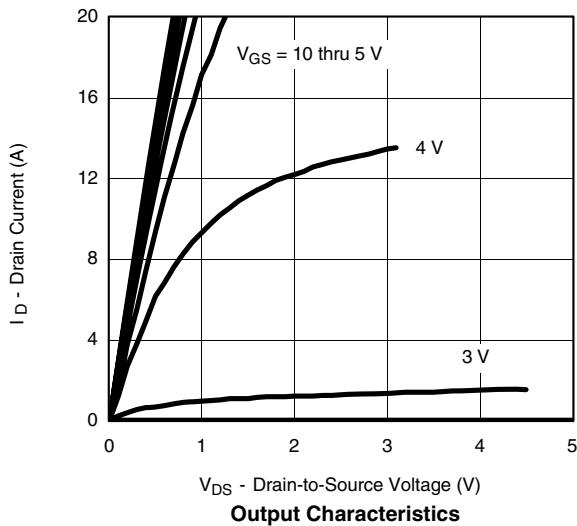
Single Pulse Power, Junction-to-Ambient

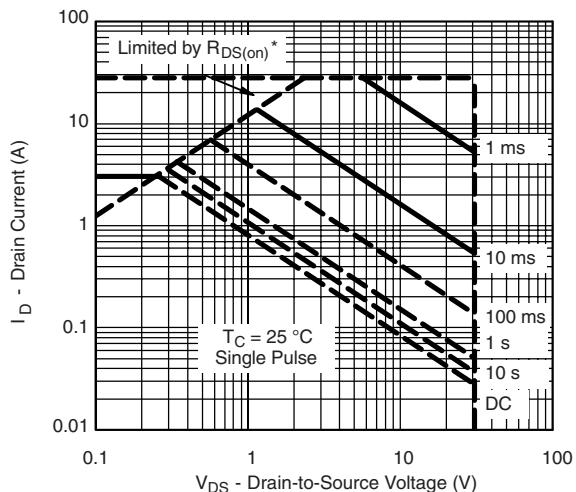
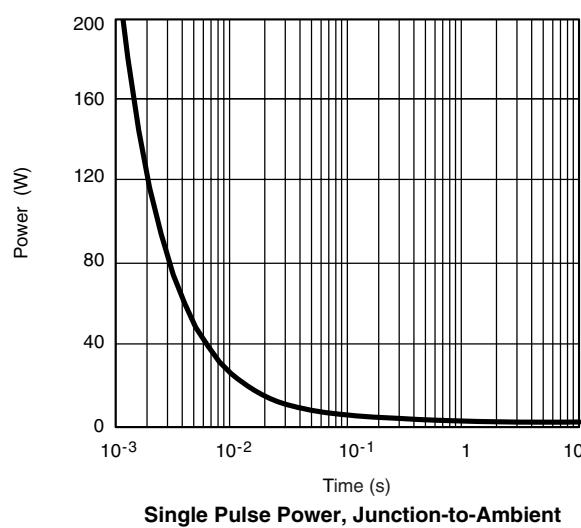
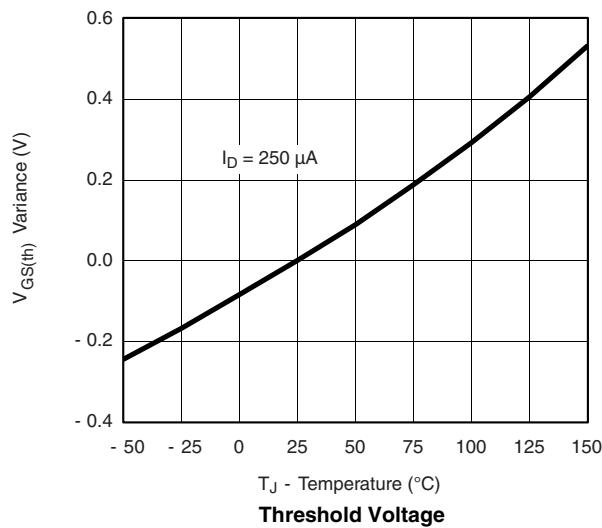
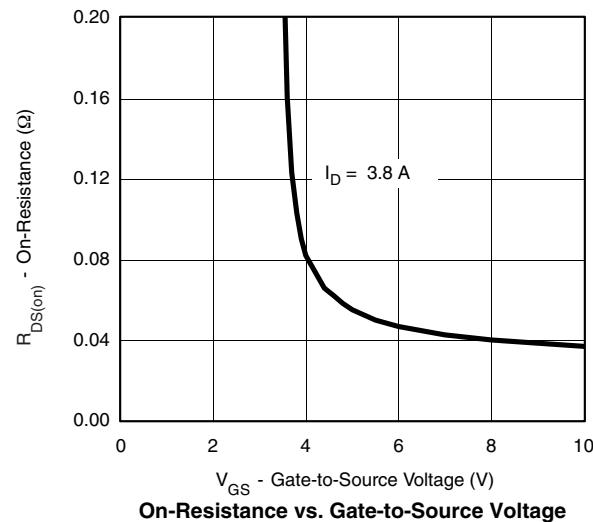
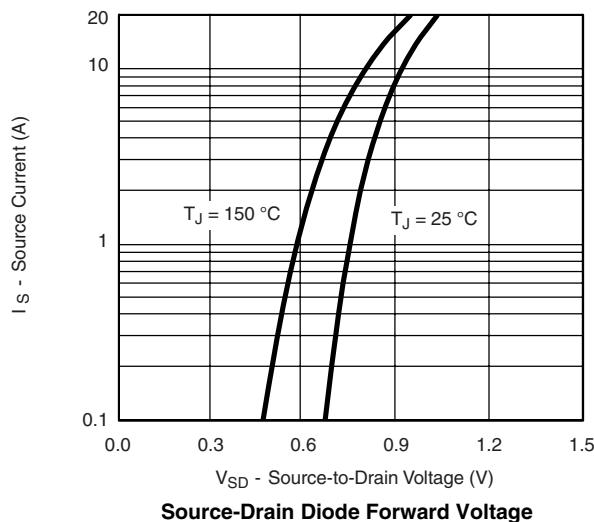


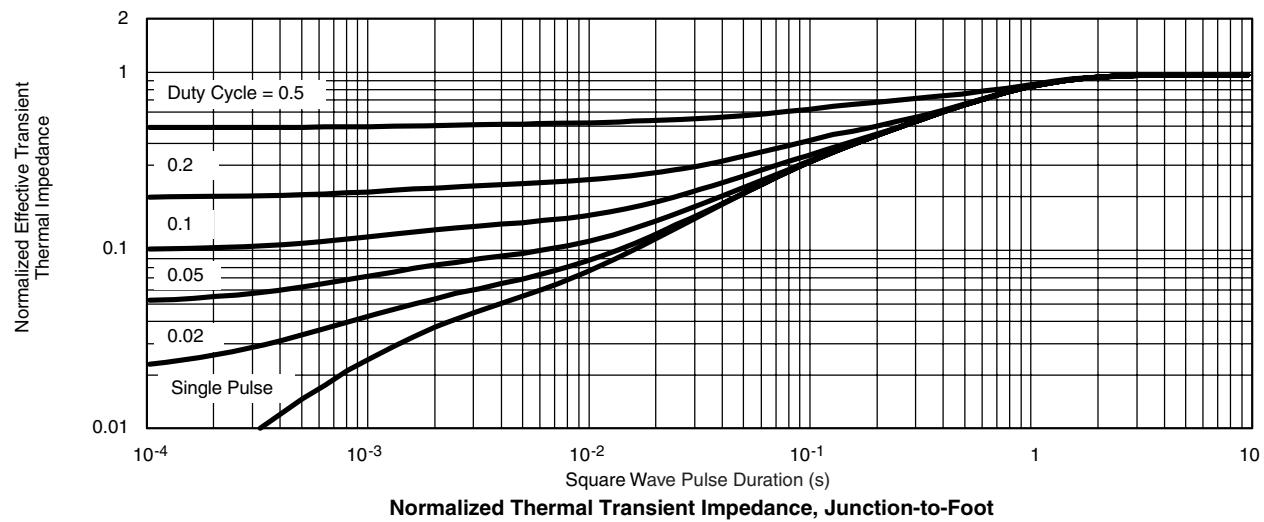
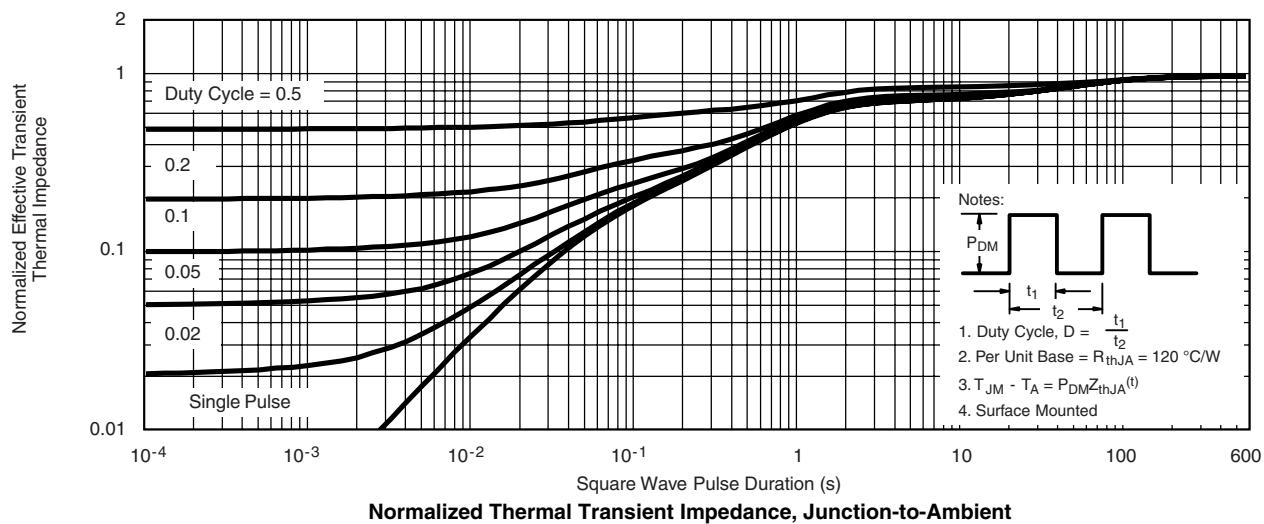
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified  
Safe Operating Area, Junction-to-Case

**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


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